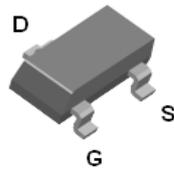


# PM597BA

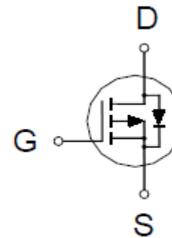
## P-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-20V	43mΩ @ $V_{GS} = -4.5V$	-4.5A



SOT-23(S)



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Gate-Source Voltage		$V_{GS}$	±12	V
Continuous Drain Current	$T_A = 25\text{ °C}$	$I_D$	-4.5	A
	$T_A = 70\text{ °C}$		-3.6	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-16	
Power Dissipation <sup>3</sup>	$T_A = 25\text{ °C}$	$P_D$	1.4	W
	$T_A = 70\text{ °C}$		0.9	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	°C

### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10s$	$R_{\theta JA}$		90	°C / W
Junction-to-Ambient <sup>2</sup>	Steady-State	$R_{\theta JA}$		130	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper.

<sup>3</sup>The Power dissipation is based on  $R_{\theta JA}$   $t \leq 10s$  value.

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## P-Channel Enhancement Mode MOSFET

### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.7	-0.8	-1.3	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V			-1	μA
		V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C			-10	
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -3.5A		40	58	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.5A		30	43	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -3.5A		16		S
<b>DYNAMIC</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = -10V, f = 1MHz		801		pF
Output Capacitance	C <sub>oss</sub>			115		
Reverse Transfer Capacitance	C <sub>rss</sub>			92		
Total Gate Charge <sup>2</sup>	Q <sub>g</sub> (V <sub>GS</sub> =4.5V)	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.5A		8.7		nC
	Q <sub>g</sub> (V <sub>GS</sub> =2.5V)			5.4		
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>			1.2		
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>			2.6		
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>		V <sub>DD</sub> = -10V, V <sub>GS</sub> = -4.5V I <sub>D</sub> ≅ -3.5A, R <sub>G</sub> = 6Ω		19	
Rise Time <sup>2</sup>	t <sub>r</sub>			30		
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>			55		
Fall Time <sup>2</sup>	t <sub>f</sub>			20		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTIC ( T<sub>J</sub> = 25 °C )</b>						
Continuous Current	I <sub>S</sub>				-1	A
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = -3.5A, V <sub>GS</sub> = 0V			-1.3	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -3.5A, dI <sub>F</sub> /dt = 100A / μS		24		nS
Reverse Recovery Charge	Q <sub>rr</sub>			6		nC

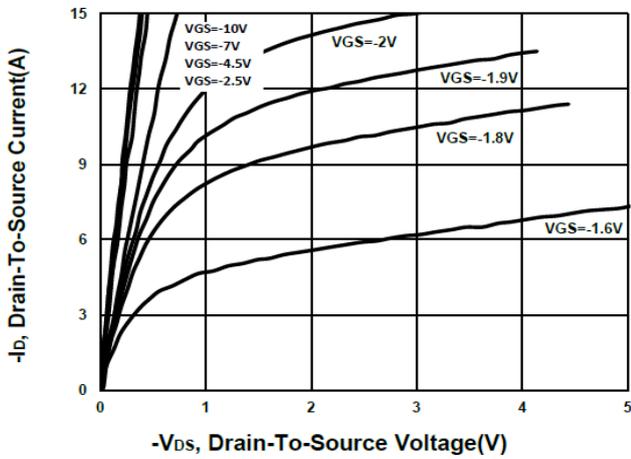
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

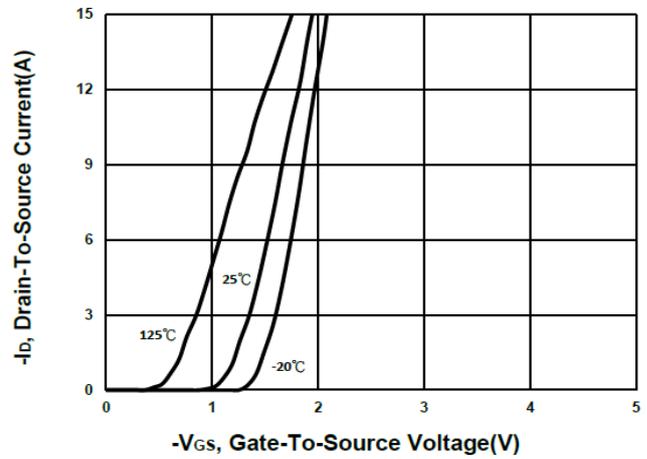
# PM597BA

## P-Channel Enhancement Mode MOSFET

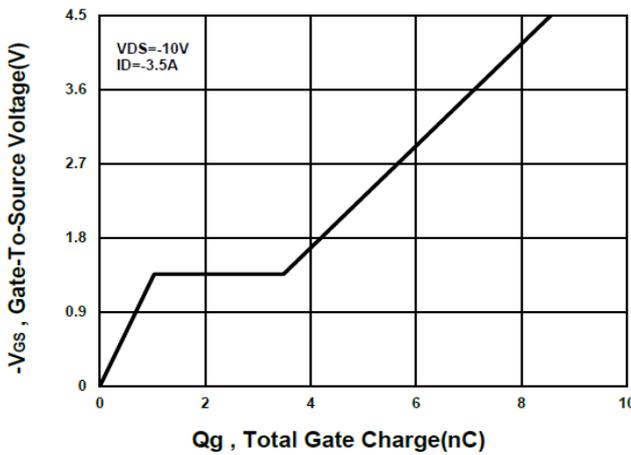
**Output Characteristics**



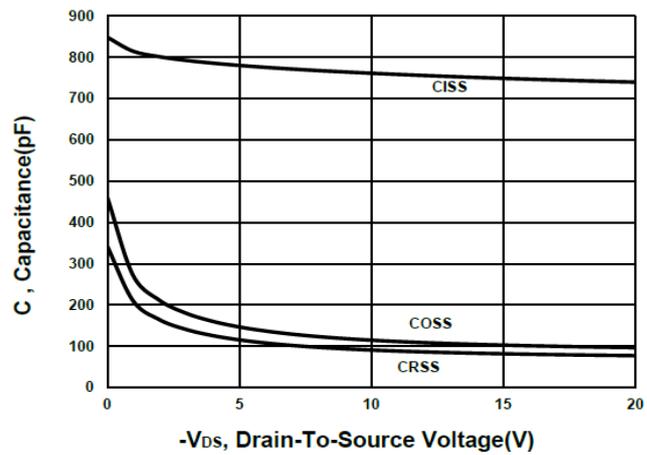
**Transfer Characteristics**



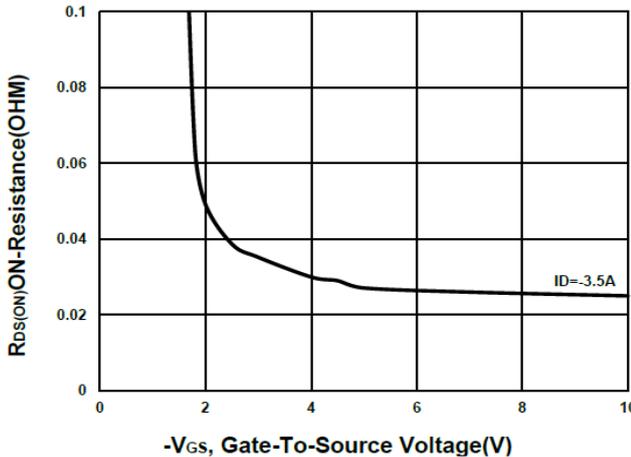
**Gate charge Characteristics**



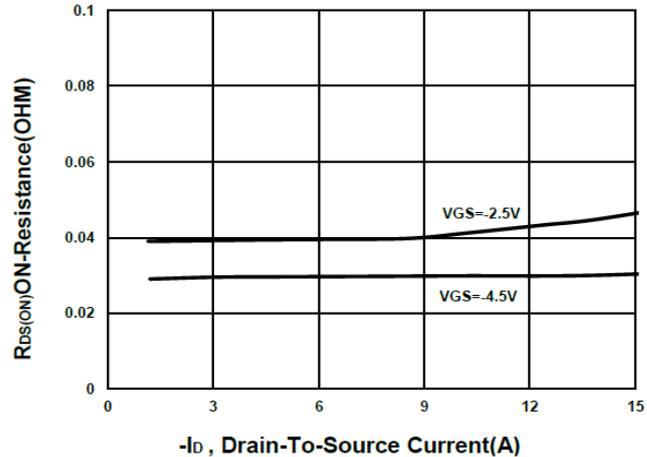
**Capacitance Characteristic**



**On-Resistance VS Gate-To-Source**



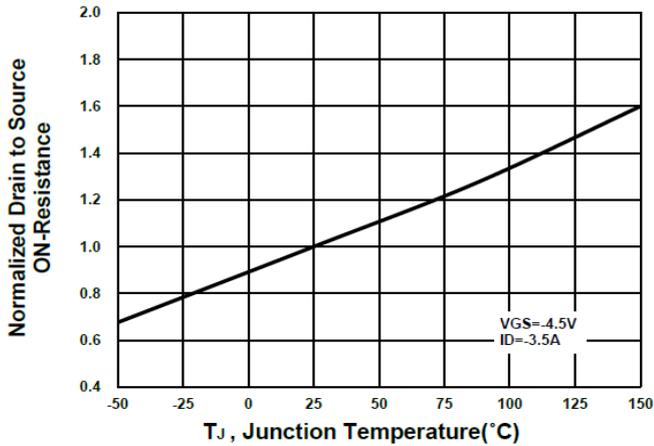
**On-Resistance VS Drain Current**



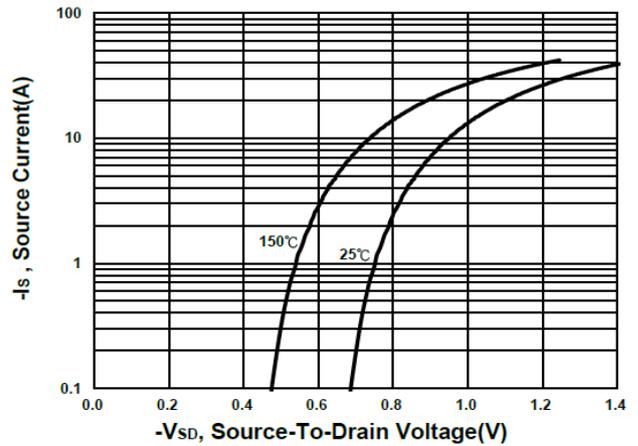
# PM597BA

## P-Channel Enhancement Mode MOSFET

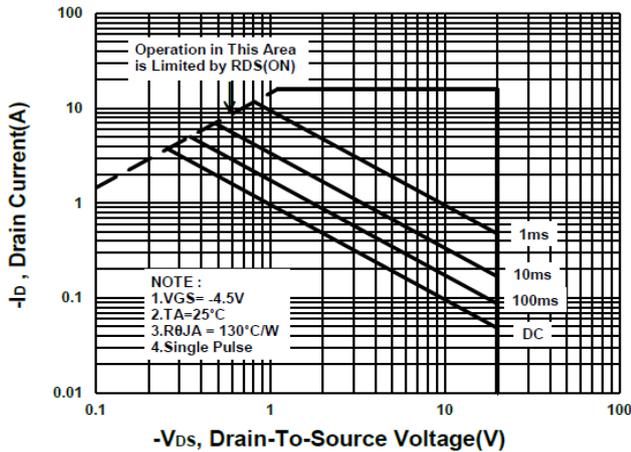
**On-Resistance VS Temperature**



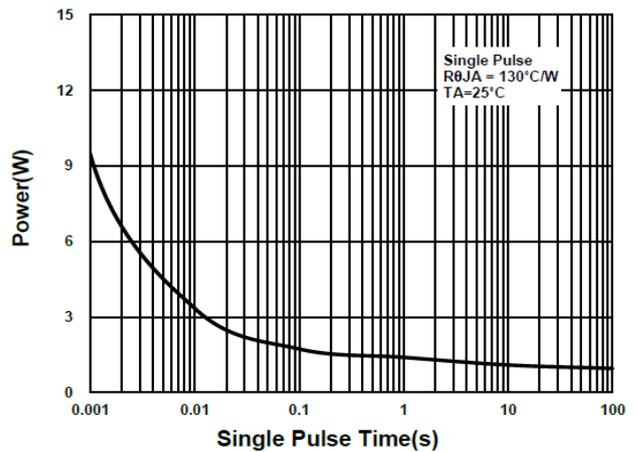
**Source-Drain Diode Forward Voltage**



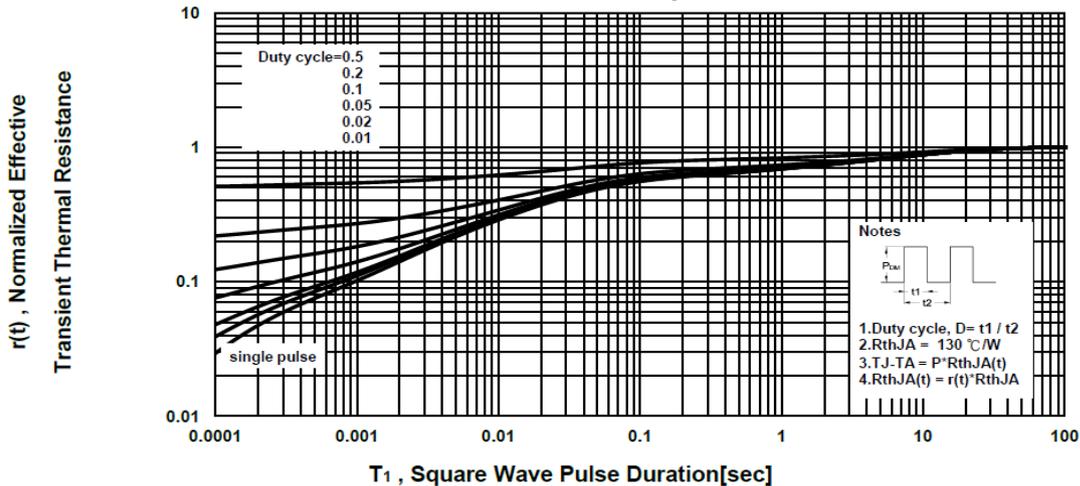
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**



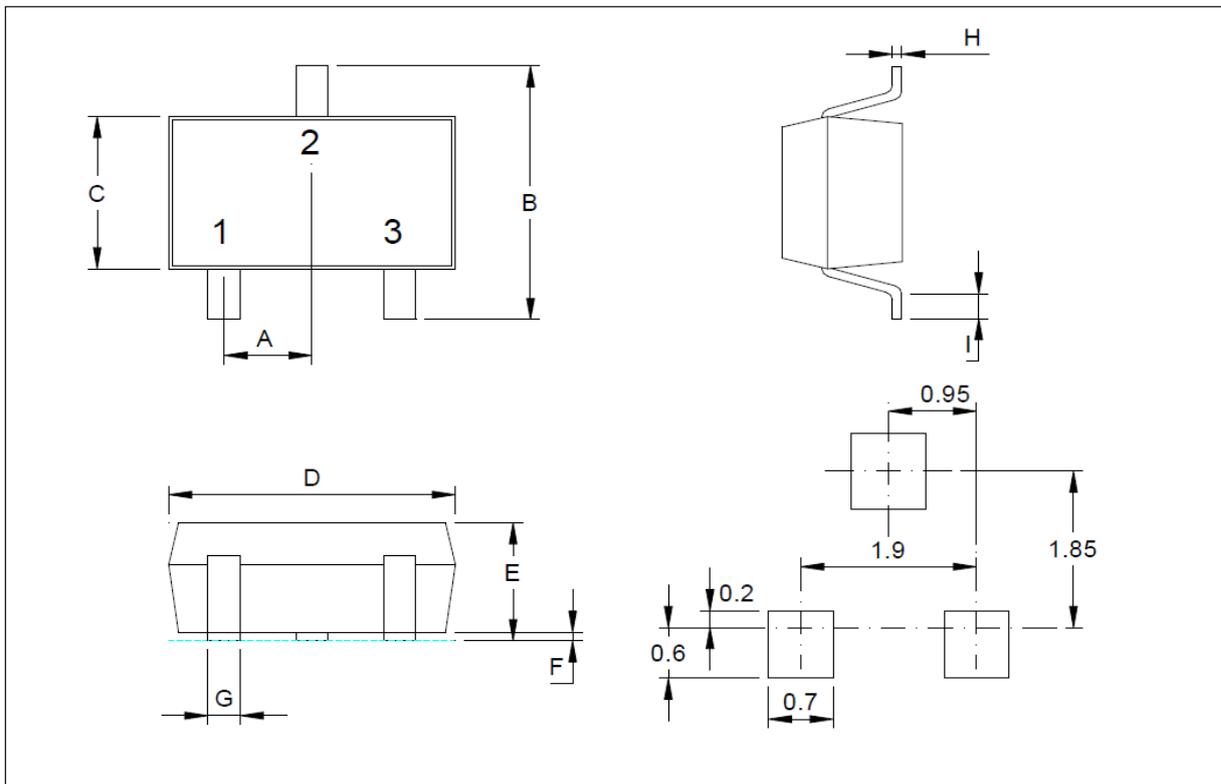
# PM597BA

## P-Channel Enhancement Mode MOSFET

### Package Dimension

### SOT-23 (S) MECHANICAL DATA

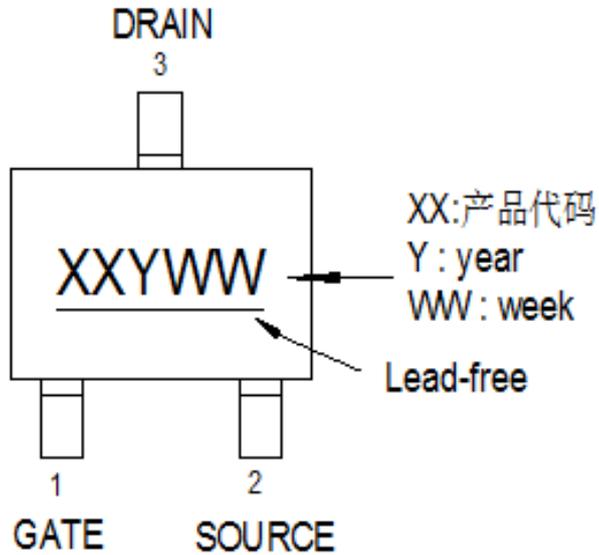
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	0.9		1	H	0.08		0.2
B	2.25		2.85	I	0.15		0.6
C	1.2		1.4				
D	2.8		3.04				
E	0.89		1.2				
F	0		0.1				
G	0.3		0.5				



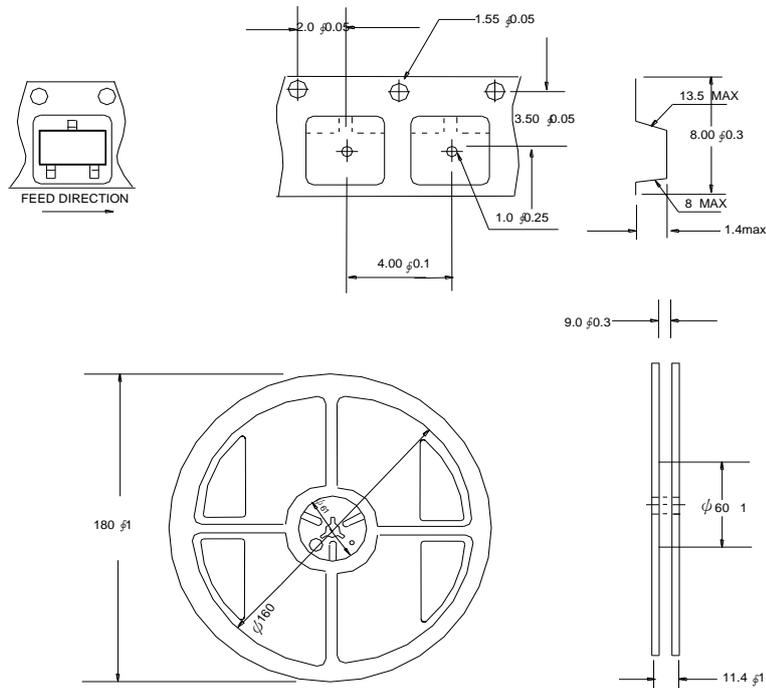
# PM597BA

## P-Channel Enhancement Mode MOSFET

### A. Marking Information (此产品代码为：7F)



### B. Tape&Reel Information:3000pcs/Reel



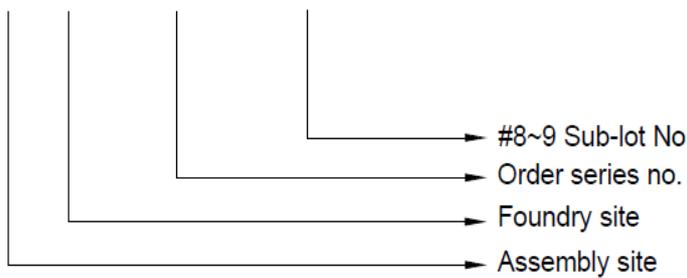
# PM597BA

## P-Channel Enhancement Mode MOSFET

### C. Lot.No. & Date Code rule

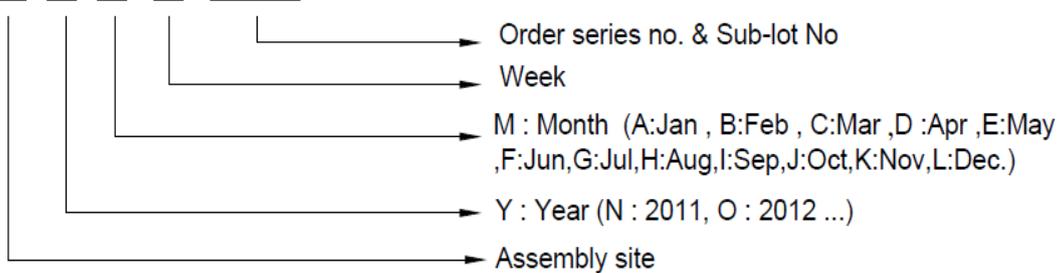
#### 1.LOT.NO.

M N 15M21 03



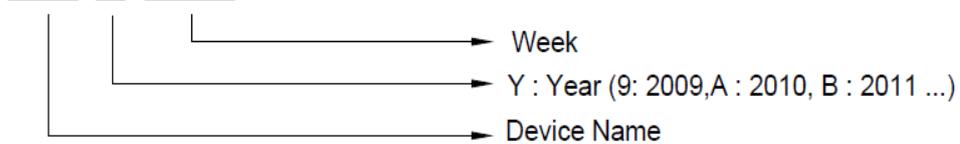
#### 2.Date Code

D Y M X XXX



#### 3.Date Code (for Small package)

XX Y WW



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## P-Channel Enhancement Mode MOSFET

### D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm
2	Font style	Times New Roman or Arial (或可区分英文"0"和数字"0", "G"和"Q"的字型即可)
3	Great Power	Height: 4 mm
4	Package	Height: 2 mm
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12
6	Device	Height: 3 mm (Max: 16 Digit)
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot
8	D/C	Height: 3 mm (Max: 7 Digit)
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed
10	Pb Free label	 Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
11	Halogen Free label	 Diameter: 1 cm bottom color: Green Font color: Black Font style: Arial
12	Scan info	Device / Lot / D/C / QTY , Insert “ / “ between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least